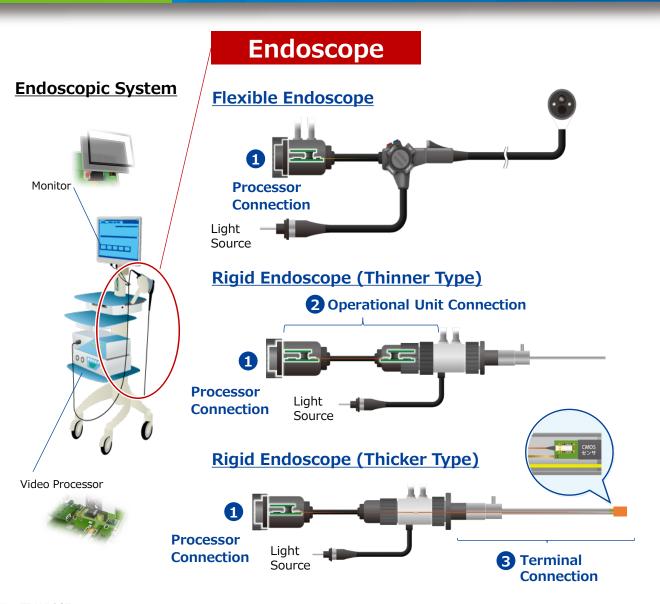
Endoscope/内視鏡スコープ



1 2 Board-to-Board for Processor/ Operational Unit Connection



Pitch: 0.4mm Stacking Height: 1.5-4.0mm No. of Pos.: 10-120



DF40T

125°C High Heat Resistance Pitch: 0.4mm Stacking Height: 1.5-7.0mm No. of Pos.: 10-120 Wide Variations



BM28

Pitch: 0.35mm Depth: 1.7mm Stacking Height: 0.6mm No. of Pos.: 2 (Power) 6-60 (Signal)



BM29

Pitch: 0.35mm
Depth: 1.5mm
Stacking Height: 0.6mm
No. of Pos.: 2 (Power)
2-24 (Signal)





BF4M

-Ultra-small Optical Transmission Module -6.25Gbps High Speed Transmission -EMI Protection



FJ

-Compact optical fiber in-line connector

-Easy and Secure Bayonet Lock

-ø0.5 Bending Resistant Fiber (GI 50/80) -ø0.9 General Purpose Fiber (GI 50/125)

